# TLE7188F 3-Phase Bridge Driver IC

# Automotive Power



Never stop thinking



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# 3-Phase Bridge Driver IC

## TLE7188F



## 1 Overview

#### Features

- Compatible to very low ohmic normal level input N-Channel MOSFETs
- Separate input for each MOSFET
- PWM frequency up to 25kHz
- Fulfils specification down to 5.5V supply voltage
- Low EMC sensitivity and emission
- VQFN-48 package with exposed heat slug
- Control inputs with TTL characteristics
- · Separate source connection for each MOSFET
- Integrated minimum dead time
- Shoot through protection
- Short circuit protection with fixed detection level
- · Disable function and sleep mode
- · Detailed diagnosis
- Thermal overload warning for driver IC
- Integrated over current warning
- Integrated current sense amplifier
- 0 to 100% duty cycle
- Green Product (RoHS compliant)
- AEC Qualified

#### Description

The TLE7188F is a driver IC dedicated to control the 6 to 12 external MOSFETs forming the converter for high current 3 phase motor drives in the automotive sector. It incorporates features like short circuit detection, diagnosis and high output performance and combines it with typical automotive specific requirements like full functionality even at low battery voltages. Its 3 high side and 3 low side output stages are powerful enough to drive MOSFETs with 400nC gate charge with approx. 150 ns fall and rise times.

Typical applications are cooling fan, water pump, electro-hydraulic and electric power steering. The TLE7188F is designed for 12 V power net.

Туре	Package	Marking
TLE7188F	VQFN-48	TLE7188F



VQFN-48



**Block Diagram** 

# 2 Block Diagram

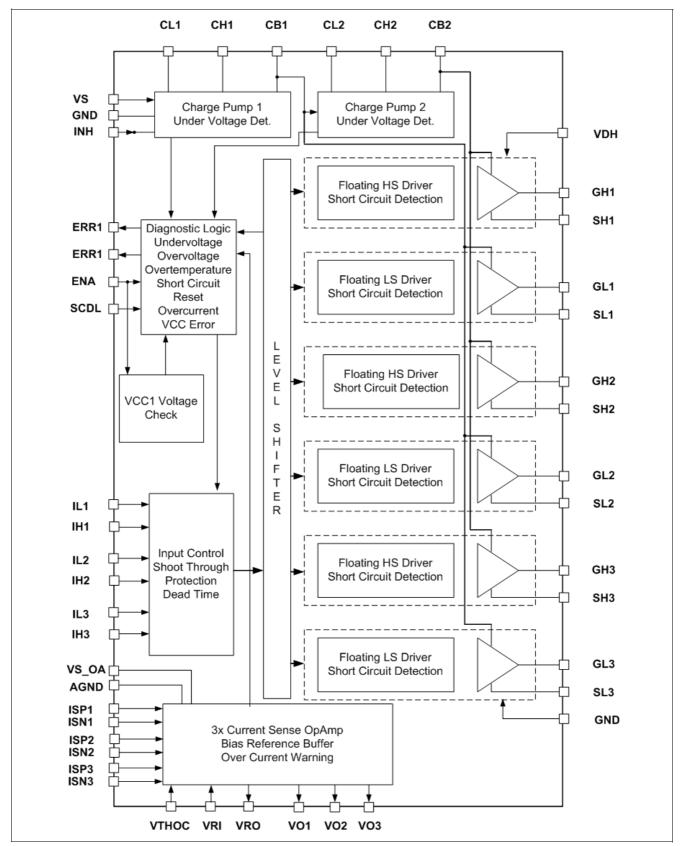


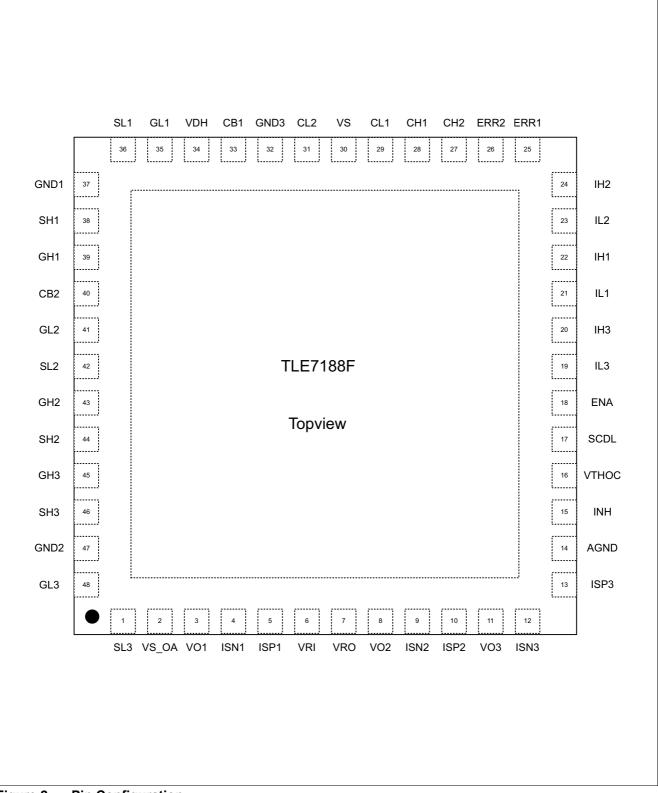
Figure 1 Block Diagram



**Pin Configuration** 

# 3 Pin Configuration

## 3.1 Pin Assignment TLE7188F







**Pin Configuration** 

# 3.2 Pin Definitions and Functions

1       SL3       Connection to source low side switch 3         2       VS_OA       Voltage supply I-DC Link OpAmps and voltage reference buffer         3       VO1       Output of OpAmp 1 for shunt signal amplification         4       ISN1       -Input of OpAmp 1 for shunt signal amplification         5       ISP1       + Input of OpAmp 1 for shunt signal amplification         6       VRI       Input of blas reference amplifier         7       VRO       Output of OpAmp 2 for shunt signal amplification         9       ISN2       - Input of OpAmp 2 for shunt signal amplification         10       ISP2       + Input of OpAmp 3 for shunt signal amplification         11       VO3       Output of OpAmp 3 for shunt signal amplification         12       ISN3       - Input of OpAmp 3 for shunt signal amplification         13       ISP3       + Input of OpAmp 3 for shunt signal amplification         14       AGND       Analog ground especially for the current sense OpAmps         15       INH       Inhibit pin (active low)         16       VTHOC       Threshold voltage for overcurrent detection         17       SCDL       Input for lingh side switch 3 (active lingh)         18       ENA       Enable pin (active high)         19       IL3	Pin	Symbol	Function					
3       V01       Output of OpAmp 1 for shunt signal amplification         4       ISN1       - Input of OpAmp 1 for shunt signal amplification         5       ISP1       + Input of OpAmp 1 for shunt signal amplification         6       VRI       Input of bias reference amplifier         7       VRO       Output of OpAmp 2 for shunt signal amplification         9       ISN2       - Input of OpAmp 2 for shunt signal amplification         10       ISP2       + Input of OpAmp 3 for shunt signal amplification         11       VO3       Output of OpAmp 3 for shunt signal amplification         12       ISN3       - Input of OpAmp 3 for shunt signal amplification         13       ISP3       + Input of OpAmp 3 for shunt signal amplification         14       AGND       Analog ground especially for the current sense OpAmps         15       INH       Inhibit pin (active low)         16       VTHOC       Threshold voltage for overcurrent detection         17       SCDL       Input for high side switch 3 (active high)         19       IL3       Input for high side switch 3 (active low)         21       IL1       Input for high side switch 1 (active low)         22       IH1       Input for high side switch 2 (active high)         23       IL2	1	SL3	Connection to source low side switch 3					
4       ISN1       - Input of OpAmp 1 for shunt signal amplification         5       ISP1       + Input of Daymp 1 for shunt signal amplification         6       VRI       Input of bias reference amplifier         7       VRO       Output of Daym 2 for shunt signal amplification         9       ISN2       - Input of OpAmp 2 for shunt signal amplification         10       ISP2       + Input of OpAmp 3 for shunt signal amplification         11       VO3       Output of OpAmp 3 for shunt signal amplification         12       ISN3       - Input of OpAmp 3 for shunt signal amplification         13       ISP3       + Input of OpAmp 3 for shunt signal amplification         14       AGND       Analog ground especially for the current sense OpAmps         15       INH       Inhibit pin (active low)         16       VTHOC       Threshold voltage for overcurrent detection         17       SCDL       Input for low side switch 3 (active high)         19       IL1       Input for low side switch 1 (active low)         20       IH3       Input for low side switch 1 (active low)         21       IL1       Input for low side switch 2 (active high)         22       IH1       Input for low side switch 2 (active high)         23       IL2       Inpu	2	VS_OA	Voltage supply I-DC Link OpAmps and voltage reference buffer					
5       ISP1       + Input of OpAmp 1 for shunt signal amplification         6       VRI       Input of bias reference amplifier         7       VRO       Output of bias reference amplifier         8       VO2       Output of OpAmp 2 for shunt signal amplification         9       ISN2       - Input of OpAmp 2 for shunt signal amplification         10       ISP2       + Input of OpAmp 3 for shunt signal amplification         11       VO3       Output of OpAmp 3 for shunt signal amplification         12       ISN3       - Input of OpAmp 3 for shunt signal amplification         13       ISP3       + Input of OpAmp 3 for shunt signal amplification         14       AGND       Analog ground especially for the current sense OpAmps         15       INH       Inhibit pin (active low)         16       VTHOC       Threshold voltage for overcurrent detection         17       SCDL       Input for low side switch 3 (active high)         20       IL3       Input for low side switch 1 (active high)         21       IL1       Input for ligh side switch 1 (active low)         23       IL2       Input for high side switch 2 (active high)         24       IH2       Input for high side switch 2 (active low)         25       ERR1       Error signal 1<	3	VO1	Output of OpAmp 1 for shunt signal amplification					
6     VRI     Input of bias reference amplifier       7     VRO     Output of Damp 2 for shunt signal amplification       8     VO2     Output of OpAmp 2 for shunt signal amplification       9     ISN2     - Input of OpAmp 2 for shunt signal amplification       10     ISP2     + Input of OpAmp 3 for shunt signal amplification       11     VO3     Output of OpAmp 3 for shunt signal amplification       12     ISN3     - Input of OpAmp 3 for shunt signal amplification       13     ISP3     + Input of OpAmp 3 for shunt signal amplification       14     AGND     Analog ground especially for the current sense OpAmps       15     INH     Inhibit pin (active low)       16     VTHOC     Threshold voltage for overcurrent detection       17     SCDL     Input for bigs isde switch 3 (active high)       18     ENA     Enable pin (active high)       19     IL3     Input for low side switch 3 (active low)       21     IL1     Input for high side switch 1 (active low)       23     IL2     Input for high side switch 2 (active low)       24     IH2     Input for pump capacitor of charge pump 1       26     ERR1     Error signal 2       27     CH2     + terminal for pump capacitor of charge pump 1       28     CH1     + terminal for pump capacitor of	4	ISN1	- Input of OpAmp 1 for shunt signal amplification					
7VROOutput of bias reference amplifier8VO2Output of OpAmp 2 for shunt signal amplification9ISN2- Input of OpAmp 2 for shunt signal amplification10ISP2+ Input of OpAmp 3 for shunt signal amplification11VO3Output of OpAmp 3 for shunt signal amplification12ISN3- Input of OpAmp 3 for shunt signal amplification13ISP3+ Input of OpAmp 3 for shunt signal amplification14AGNDAnalog ground especially for the current sense OpAmps15INHInhibit pin (active low)16VTHOCThreshold voltage for overcurrent detection17SCDLInput for low side switch 3 (active high)19IL3Input for low side switch 3 (active high)20IH3Input for high side switch 1 (active low)21IL1Input for high side switch 1 (active low)23IL2Input for high side switch 1 (active low)24IH2Input for high side switch 2 (active low)25ERR1Error signal 126ERR2Error signal 227CH2+ terminal for pump capacitor of charge pump 129CL1- terminal for pump capacitor of charge pump 130VSVoltage supply31CL2- terminal for pump capacitor of charge pump 134VDHConnection to drain of high side switch 135GL1Output to gate low side switch 136SL1Connection to source low side switch 137GND3<	5	ISP1	+ Input of OpAmp 1 for shunt signal amplification					
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20IH3Input for high side switch 3 (active low)21IL1Input for low side switch 1 (active high)22IH1Input for high side switch 1 (active low)23IL2Input for low side switch 2 (active high)24IH2Input for high side switch 2 (active low)25ERR1Error signal 126ERR2Error signal 227CH2+ terminal for pump capacitor of charge pump 228CH1+ terminal for pump capacitor of charge pump 129CL1- terminal for pump capacitor of charge pump 130VSVoltage supply31CL2- terminal for pump capacitor of charge pump 232GND3Logic and power ground33CB1Buffer capacitor for charge pump 134VDHConnection to drain of high side switch 136SL1Connection to source low side switch 137GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	18	ENA	Enable pin (active high)					
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32GND3Logic and power ground33CB1Buffer capacitor for charge pump 134VDHConnection to drain of high side switches for short circuit detection35GL1Output to gate low side switch 136SL1Connection to source low side switch 137GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	30	VS	Voltage supply					
33CB1Buffer capacitor for charge pump 134VDHConnection to drain of high side switches for short circuit detection35GL1Output to gate low side switch 136SL1Connection to source low side switch 137GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	31	CL2	- terminal for pump capacitor of charge pump 2					
34VDHConnection to drain of high side switches for short circuit detection35GL1Output to gate low side switch 136SL1Connection to source low side switch 137GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	32	GND3	Logic and power ground					
35GL1Output to gate low side switch 136SL1Connection to source low side switch 137GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	33	CB1	Buffer capacitor for charge pump 1					
36SL1Connection to source low side switch 137GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	34	VDH	Connection to drain of high side switches for short circuit detection					
37GND1Logic and power ground38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	35	GL1	Output to gate low side switch 1					
38SH1Connection to source high side switch 139GH1Output to gate high side switch 1	36	SL1	Connection to source low side switch 1					
39     GH1     Output to gate high side switch 1	37	GND1	Logic and power ground					
	38	SH1	Connection to source high side switch 1					
40     CB2     Buffer capacitor for charge pump 2	39	GH1	Output to gate high side switch 1					
	40	CB2	Buffer capacitor for charge pump 2					





## **Pin Configuration**

Pin	Symbol	Function		
41	GL2	Output to gate low side switch 2		
42	SL2 Connection to source low side switch 2			
43	GH2	Output to gate high side switch 2		
44	SH2	Connection to source high side switch 2		
45	GH3	Output to gate high side switch 3		
46	SH3	Connection to source high side switch 3		
47	GND2	Logic and power ground		
48	GL3	Output to gate low side switch 3		



# 4 General Product Characteristics

## 4.1 Absolute Maximum Ratings

## Absolute Maximum Ratings <sup>1)</sup>

-40 °C  $\leq T_j \leq$  150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values		Unit	Conditions
			Min.	Max.		
Voltage	S	<u>.</u>		U		
4.1.1	Supply voltage	Vs	-4.0	45	V	with 10Ohm and 1µF
4.1.2	Supply voltage	Vs	-0.3	45	V	-
4.1.3	Supply voltage	Vs	-0.3	47	V	<i>t</i> <sub>p</sub> <200ms
4.1.4	Voltage range at IHx,ILx,ERRx, VOx, VTHOC, ENA, VRI, VRO, SCDL	V <sub>DP</sub>	-0.3	6.0	V	-
4.1.5	Voltage range at INH	$V_{INH}$	-0.3	18.0	V	-
4.1.6	Voltage range at VS_OA	$V_{\rm VS_OA}$	-0.3	18.0	V	-
4.1.7	Voltage range at SLx	V <sub>SL</sub>	-7	7	V	-
4.1.8	Voltage range at SHx	V <sub>SH</sub>	-7	45	V	-
4.1.9	Voltage range at GLx	$V_{GL}$	-7	18	V	-
4.1.10	Voltage range at GHx	$V_{GH}$	-7	55	V	-
4.1.11	Voltage difference Gxx-Sxx	V <sub>GS</sub>	-0.3	15	V	-
4.1.12	Voltage range at VDH	$V_{\rm VDH}$	-0.3	55	V	$V_{\rm INH}$ =high
4.1.13	Voltage range at VDH	V <sub>VDH</sub>	-4.0	55	V	$V_{\rm INH}$ =high; with $R_{\rm VDH}$ >70Ω; 200ms, 5x
4.1.14	Voltage range at VDH	V <sub>VDH</sub>	-0.3	28	V	V <sub>INH</sub> =low
4.1.15	Voltage range at VDH	V <sub>VDH</sub>	-4.0	28	V	$V_{\rm INH}$ =low; with $R_{\rm VDH}$ >70Ω; 200ms, 5x
4.1.16	Voltage range at CL1	V <sub>CL1</sub>	-0.3	25	V	-
4.1.17	Voltage range at CH1, CB1	$V_{\rm CH1}, V_{\rm CB1}$	-0.3	25	V	-
4.1.18	Voltage difference CH1-CL1	V <sub>DC1</sub>	-0.3	25	V	-
4.1.19	Voltage range at CL2	V <sub>CL2</sub>	-0.3	25	V	-
4.1.20	Voltage range at CH2, CB2	$V_{\rm CH2}, V_{\rm CB2}$	-0.3	55	V	-
4.1.21	Voltage difference CH2-CL2	$V_{\rm CP2}$	-0.3	25	V	-
4.1.22	Voltage range at ISPx, ISNx	V <sub>ISI</sub>	-5	5	V	-
4.1.23	Output current range at VOx	I <sub>VOx</sub>	-10	10	mA	-
4.1.24	Gate resistor	R <sub>Gate</sub>	2	-	Ω	-
Temper	atures		1			
4.1.25	Junction temperature	$T_{j}$	-40	150	°C	-
4.1.26	Storage temperature	T <sub>stg</sub>	-55	150	°C	-
Therma	Resistance					



#### **General Product Characteristics**

## Absolute Maximum Ratings (cont'd)<sup>1)</sup>

-40 °C  $\leq$   $T_i \leq$  150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Lim	nit Values	Unit	Conditions
			Min.	Max.		
4.1.27	Junction to case	R <sub>thJC</sub>	-	5	K/W	-
Power D	issipation	L	_			
4.1.28	Power Dissipation (DC) @ TCASE=125°C	P <sub>tot</sub>	-	2	W	-
ESD Sus	sceptibility	L		4		
4.1.29	ESD Resistivity <sup>2)</sup>	$V_{ESD}$	-	2	kV	Gxx excluded
4.1.30		$V_{ESD}$	-	1	kV	
4.1.31	ESD Resistivity (charge device model) <sup>3)</sup>	$V_{ESD}$	_	750	V	

1) Not subject to production test, specified by design.

2) ESD susceptibility HBM according to EIA/JESD 22-A 114B

3) ESD susceptibility CDM according to EIA/JESD 22-C 101

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

## 4.2 Functional Range

Pos.	Parameter	Symbol	Lii	nit Values	Unit	Conditions
			Min.	Max.		
4.2.1	Supply voltage <sup>1) 2)</sup>	Vs	5.5 5.5	20 28	V	DC <i>T</i> <sub>A</sub> =25°C; <i>t</i> <1min
4.2.2	Duty cycle <sup>3)</sup>	D	0	100	%	-
4.2.3	PWM frequency	$f_{\sf PWM}$	0	25	kHz	Total gate charge 400nC
4.2.4	Quiescent current <sup>4)</sup>	IQ	-	30	μA	V <sub>S</sub> ,V <sub>DH</sub> <20 ∨
4.2.5	Quiescent current into VDH	$I_{\rm Q_VDH}$	-	30	μA	V <sub>DH</sub> <20V; V <sub>s</sub> pin open
4.2.6	Supply current at Vs	I <sub>Vs</sub>			mA	∫ <sub>PWM</sub> =20kHz Q <sub>G</sub> =170nC:
			-	110		$V_{\rm S} = 5.5 V$
			-	110		V <sub>s</sub> = 14V
			-	90		V <sub>S</sub> = 18V
			-	90		V <sub>S</sub> = 20V
4.2.7	Supply current at Vs (device	I <sub>Vs(o)</sub>	-	60	mA	<i>V</i> s=5.5V 18V
	disabled by ENA)		-	50		<i>V</i> s=18V 20V
4.2.8	Supply current at VS_OA	$I_{Vs_OA}$	-	30	mA	V <sub>S_OA</sub> =5.5 6.5V
4.2.9	Voltage difference CB2-VDH	$V_{\rm CB2-VDH}$	-0.3	20	V	Operation mode
4.2.10	Junction temperature	$T_{j}$	-40	150	°C	

1) max ratings for Tj has to be considered as well



#### **General Product Characteristics**

- 2) For proper start up minimum Vs=6.5V is required
- 3) Duty cycle is referred to the high side input command (IHx); The duty cycles can be driven continuously and fully operational
- 4) total current consumption from power net (Vs and VDH)
- Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.
- Note: If the voltage difference between CB2 and SHx is smaller than 2V during normal operation, there is a risk that the high side output can switch on and off without a corresponding input signal. As soon as this supply voltage recovers and the input signal changes, the output stage is automatically aligned to the input again.

## 4.3 Default State of Inputs

#### Table 1 Default State of Inputs

Characteristic	State	Remark
Default state of ILx (if ILx left open)	Low	Low side MOSFETs off
Default state of IHx (if IHx left open)	High	High side MOSFETs off
Default state of ENA (if ENA left open)	Low	Device/outputs disabled
Default state of INH (if INH left open)	Low	Sleep mode, $I_Q$ < 30 µA
$\label{eq:constraint} \hline {\mbox{Default State of sense amplifier output V}_{OX}} \\ (ISPx=ISNx=0V)$	Zero ampere equivalent	-
Status of the device and the outputs when ENA=INH='1'	Device active and outputs functional	V <sub>s</sub> =5.5 28V
Pull up or pull down integrated resistors Ixx, ENA	30k <i>Ω</i> +/-40%	-
Pull down integrated resistor INH	45kΩ+/-40%	-

Note: The load condition "C=22nF;  $R_{Load}=1\Omega$ " in the paragraph "Electrical characteristics / Dynamic characteristic" means that  $R_{Load}$  is connected between the output Gxx and the positive terminal of the C. The negative terminal of the C is connected to GND and the corresponding Sxx. The voltage is measured at the positive terminal of the C



# 5 Description and Electrical Characteristics

## 5.1 MOSFET Driver

## 5.1.1 Output Stages

The 3 low side and 3 high side powerful push-pull output stages of the TLE7188F are all floating blocks, each with its own source pin. This allows the direct connection of the output stage to the source of each single MOSFET, allowing a perfect control of each gate-source voltage even when 200A are driven in the bridge with rise and fall times clearly below  $1\mu$ s.

All 6 output stages have the same output power and thanks to the used charge pump principle they can be switched all up to 25kHz.

Its output stages are powerful enough to drive 6 MOSFETs with 400nC gate charge each or even to run 12 MOSFETs with 200nC each.

Maximum allowed power dissipation, max. junction temperature and the capabilities of the charge pump limit the use for higher frequencies.

Each output stage has its own short circuit detection block. For more details about short circuit detection see **Chapter 5.2.1**.

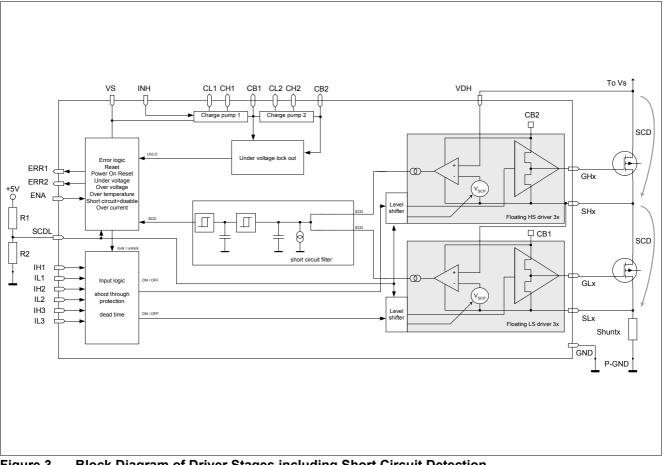


Figure 3 Block Diagram of Driver Stages including Short Circuit Detection



## 5.1.2 Operation at Vs<12V - Integrated Charge Pumps

The TLE7188F provides a feature tailored to the requirements in 12V automotive applications. Often the operation of an application has to be assured even at 9V supply voltage or lower. Normally bridge driver ICs provide in such conditions clearly less than 9V to the gate of the external MOSFETs, increasing their  $R_{DSon}$  and the associated power dissipation.

The TLE7188F has two charge pump circuitries for external capacitors.

The operation of the charge pumps is independent upon the pulse pattern of the MOSFETs.

The output of the charge pumps are regulated. The first charge pump doubles the supply voltage as long as it is below 8V. At 8V supply voltage and above, charge pump 1 regulates its output to 15V typically. Above 15V supply voltage, the output voltage of charge pump 1 will increase linearly.Yet, the output will not exceed 25V.

Charge pump 2 is regulated as well but it is pumped to the voltage on Vs. Normally VDH and Vs are in the same voltage range. The driver is not designed to have significant higher voltages at VDH compared to Vs. This would lead to reduced supply voltages for the high side output stages.

Charge pump 1 supplies the low side MOSFETS and output stages for the low side MOSFETs with sufficient voltage to assure 10V at the MOSFETs' gate even if the supply voltage is below 10V. Charge pump 2 supplies the output stages for the high side MOSFETs with sufficient voltage to assure 10V at the MOSFETs' gate. In addition, the charge pump 1 supplies most of the internal circuits of the driver IC, including charge pump 2. Output of charge pump 1 is the buffer capacitor CB1 which is referenced to GND.

Charge pump 2 supplies the high side MOSFETs and the output stages for the high side MOSFETs with sufficient voltage to assure 10V at the high side MOSFET gate. Output of charge pump 2 is buffer capacitor CB2 which is referenced to VDH.

This concept allows to drive all external MOSFETs in the complete duty cycle range of 0 to 100% without taking care about recharging of any bootstrap capacitors.

This simplifies the use in all applications especially in motor drives with block wise commutation.

The charge pumps are only deactivated when the device is put into sleep mode via INH.

During Start Up of the TLE7188F the external MOSFETs should be kept off until the charge pumps have ramped up to their final values. Hence, following procedure is recommended for Start Up:

- keep ENA = low (output stages disabled, all MOSFETs off, signals on IHx and ILx don't care) or

ENA = high (output stages enabled) and IHx = high and ILx = low (all MOSFETs off)

- apply the supply voltage to the TLE7188F and pull INH = high (the order does not matter)

- wait until the charge pump capacitors are fully charged (pls. see "Wake up time")

- the TLE7188F is now ready for normal operation (pull ENA = high and apply the PWM patterns to IHx and ILx)

The size of the charge pump capacitors (pump capacitors CPx as well as buffer capacitors CBx) can be varied between 1  $\mu$ F and 4.7  $\mu$ F. Yet, larger capacitor values result in higher charge pump voltages and less voltage ripple on the charge pump buffer capacitors CBx (which supply the internal circuits as well as the external MOSFETs, pls. see above). Besides the capacitance values the ESR of the buffer capacitors CBx determines the voltage ripple as well. It is recommended to use buffer capacitors CBx that have small ESR.

Pls. see also **Chapter 5.1.3** for capacitor selection.

## 5.1.3 Sleep Mode

When the INH pin is set to low, the driver will be set to sleep mode. The INH pin switches off the complete supply structure of the device and leads finally to an intervillage shut down of the complete driver. Enabling the device with the INH pin means to switch on the supply structure. The device will run through power on reset during wake up. It is recommended to perform a Reset by ENA after Wake up to remove possible ERR signals; Reset is performed by keeping ENA pin low until the charge pump voltages have ramped up.

Enabling and disabling with the INH pin is not very fast. For fast enable / disable the ENA pin is recommended.



When the TLE7188F is in INH mode (INH is low) or when the supply voltage is not available on the Vs pin, then the driver IC is not supplied, the charge pumps are inactive and the charge pump capacitors are discharged. Pin CB2 (+ terminal of buffer capacitor 2) will decay to GND. When the battery voltage is still applied to VDH (- terminal of buffer capacitor 2) the buffer capacitor 2 will slowly charged to battery voltage, yet with reversed polarity compared to the polarity during regular operation. Hence, it is important to use a buffer capacitor 2 (CB2) that can withstand both, +25 V during operation mode and  $-V_{BAT}$  during INH mode, e.g. a ceramic capacitor. In case of load dump during INH mode, the negative voltage across CB2 will be clamped to -31 V (CB2 referenced to VDH).

## 5.1.4 Electrical Characteristics

## **Electrical Characteristics MOSFET drivers - DC Characteristics**

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C,  $f_{\rm PWM}$  < 25kHz, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
5.1.1	Low level output voltage	V <sub>G_LL</sub>	-	-	0.2	V	<i>I</i> =30mA	
5.1.2	High level output voltage, Low Side	V <sub>G_HL</sub>	7.5	-	13	V	Vs=5.58V; /=-2mA	
5.1.3	High level output voltage, High Side	$V_{\rm G_{HL}}$	6.5	-	13	V	Vs=5.58V; /=-2mA	
5.1.4	High level output voltage	$V_{\rm G_{HL}}$	9	-	13	V	Vs=820V; /=-2mA	
5.1.5	High level output voltage difference	$d_{\rm VG_H}$	_	_	1.0	V	/=-100mA; //s=20V	
5.1.6	Gate drive output voltage	V <sub>GS1_D</sub>	-	-	0.2	V	Disabled; 5.5V< <i>V</i> s<28V; <i>I</i> =10mA	
5.1.7	Gate drive output voltage Tj=-40°C Tj=25°C Tj=150°C	V <sub>GS2_5</sub>			1.4 1.2 1.0	V	UVLO; Vs<=5.5V	
5.1.8					- 1.4 1.2 1.0	V	Over voltage	
5.1.9	Gate drive output voltage low side	$V_{\text{GS}_5}$	_	_	0.2	V	Over voltage	
5.1.10	Low level input voltage of Ixx, ENA	V	_	_	1.0	V	-	
5.1.11	High level input voltage of Ixx, ENA		2.0	_	_	V	-	
5.1.12	Low level input voltage of INH	$V_{1\_LL}$	_	_	0.75	V	-	
5.1.13	High level input voltage of INH	V <sub>I_HL</sub>	2.1	_	_	V	-	
5.1.14	Input hysteresis of IHx, ILx, ENA		50	_		mV	<i>V</i> s=5.58V	
5.1.15	Input hysteresis of IHx, ILx, ENA	$d_{\rm VI}$	100	200		mV	Vs=820V	
5.1.16	Output bias current SHx	I <sub>SHx</sub>	-1.6	-1.0	-0.3	mA	Vs=5.520V; V <sub>SHx</sub> =0(Vs+1); V <sub>ILx</sub> =low; V <sub>IHx</sub> =high	
5.1.17	Output bias current SLx	I <sub>SLx</sub>	-1.6	-1.0	-0.3	mA	Vs=5.520V; $V_{SLx}=07V;$ $V_{ILx}=low; V_{IHx}=high$	



## **Electrical Characteristics MOSFET drivers - Dynamic Characteristics**

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C,  $F_{\rm PWM}$  < 25kHz, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
5.1.18	Fixed internal dead time	t <sub>DT</sub>	50	-	200	ns	-	
5.1.19	Turn on current, peak	I <sub>G(on)</sub>	-	-0.8	-	A	$V_{Gxx}-V_{Sxx}=0V;$ Vs=5.58V; C=22nF; $R_{Load}=1\Omega$	
5.1.20	Turn on current, peak	$I_{\rm G(on)}$	-	-1.5	_	A	$V_{Gxx}-V_{Sxx}=0V;$ Vs=820V; C=22nF; $R_{Load}=1\Omega$	
5.1.21	Turn off current, peak	$I_{\rm G(off)}$	-	1.5	-	A	$V_{Gxx}-V_{Sxx}=10V;$ Vs=820V; C=22nF; $R_{Load}=1\Omega$	
5.1.22	Rise time (20-80%) $T_{j} = -40^{\circ}C$ $T_{j} = 25^{\circ}C$ $T_{j} = 150^{\circ}C$	t <sub>G_rise</sub>	-	150	400 400 700	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.23	Fall time (20-80%) $T_{\rm j} = -40^{\circ}{\rm C}$ $T_{\rm j} = 25^{\circ}{\rm C}$ $T_{\rm j} = 150^{\circ}{\rm C}$	$t_{\rm G_{fall}}$	-	150	230 230 500	ns	C=22nF; $R_{Load}$ =1 $\Omega$ ;	
5.1.24	Input propagation time (low on)	t <sub>P(ILN)</sub>	90	190	290	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.25	Input propagation time (low off)	t <sub>P(ILF)</sub>	0	100	200	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.26	Input propagation time (high on)	t <sub>P(IHN)</sub>	90	190	290	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.27	Input propagation time (high off)	t <sub>P(IHF)</sub>	0	100	200	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.28	Absolute input propagation time difference (all channels turn on)	t <sub>P(an)</sub>	-	-	70	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.29	Absolute input propagation time difference (all channels turn off)	t <sub>P(af)</sub>	-	-	50	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.30	Absolute input propagation time difference (1channel high off - low on)	t <sub>P(1hfln)</sub>	-	-	180	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.31	Absolute input propagation time difference (1channel low off - high on)	t <sub>P(1lfhn)</sub>	-	-	180	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.32	Absolute input propagation time difference (all channel high off - low on)	t <sub>P(ahfin)</sub>	-	-	180	ns	C=22nF; $R_{Load}$ =1 $\Omega$	
5.1.33	Absolute input propagation time difference (all channel low off - high on)	t <sub>P(alfhn)</sub>	-	-	180	ns	C=22nF; $R_{Load}$ =1 $\Omega$	



## **Electrical Characteristics MOSFET drivers - Dynamic Characteristics**

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C,  $F_{\rm PWM}$  < 25kHz, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
5.1.34	Wake up time; INH low to high	t <sub>INH_Pen</sub>	-	-	20	ms	Driver fully functional; Vs=6.58V; V <sub>ENAx</sub> =low; CPx=CBx=4,7µF	
5.1.35	Wake up time; INH low to high	t <sub>INH_Pen</sub>	-	_	10	ms	Driver fully functional; Vs=820V; V <sub>ENAx</sub> =low; CPx=CBx=4,7µF	
5.1.36	Wake up time logic functions; INH low to high	t <sub>INH_log</sub>	-	_	10	ms	Driver fully functional; Vs=6.58V; V <sub>ENAx</sub> =low; CPx=CBx=4,7µF	
5.1.37	Wake up time logic functions; INH low to high	t <sub>INH_log</sub>	-	_	5	ms	Driver fully functional; Vs=820V; V <sub>ENAx</sub> =low; CPx=CBx=4,7µF	
5.1.38	INH propagation time to disable the output stages	t <sub>INH_Pdi</sub>	-	-	10	μs	Vs=5.58V	
5.1.39	INH propagation time to disable the output stages	t <sub>INH_Pdi</sub>	-	-	8	μs	Vs=820V	
5.1.40	INH propagation time to disable the entire driver IC	t <sub>INH_Pdi</sub>	-	-	300	μs	-	
5.1.41	Supply voltage $\rm V_s$ for Wake up	V <sub>VsWU</sub>	6.5	-	-	V	diagnostic, OpAmp working	
5.1.42	Charge pump frequency	$f_{\sf CP}$	38	55	72	kHz	-	



## 5.2 Protection and Diagnostic Functions

## 5.2.1 Short Circuit Protection

The TLE7188F provides a short circuit protection for the external MOSFETs. It is a monitoring of the drain-source voltage of the external MOSFETs. As soon as this voltage is higher than the short circuit detection limit, a capacitor will be charged. The high side and the low side output stage of the same half bridge use the same capacitor (see **Figure 3**). This capacitor is discharged permanently with a current which is smaller than the charging current. This charge and discharge ratio is specified by means of duty cycles at which a short circuit is detected or not detected.

After a delay of about 12 µs all external MOSFETs will be switched off until the driver is reset by the ENA pin. The error flag is set.

The drain-source voltage monitoring of the short circuit detection for a certain external MOSFET is active as soon as the corresponding input is set to "on" and the dead time is expired.

The short circuit detection level is adjustable in an analogue manner by the voltage setting at the SCDL pin. There is a 1:1 translation between the voltage applied to the SCDL pin and the drain-source voltage limit. For instance to trigger the SCD circuit at 1 V drain-source voltage, the SCDL pin must be set to 1 V as well. The drain-source voltage limit can be chosen between 0.5 ... 2.5 V.

A setting of 5 V at the SCDL pin will disable the short circuit protection function. Disabling the short circuit protection function has no impact on the overcurrent warning (see next chapter).

## 5.2.2 Over current Warning

The TLE7188F offers the possibility to shut down the output stages if a current threshold is reached (see Figure 4). The output of the current sense OpAmp is connected to an integrated comparator, comparing the amplified current sense signal with an external adjustable threshold value. After the comparator a blanking time (1.5  $\mu$ s typ.) is implemented to avoid false triggering caused by overswing of the current sense signal.

If the overcurrent situation is detected, only an error signal is given. During overcurrent the driver IC works normally. The error signal disappears as soon as the current decreases below the overcurrent limit set on the VTHOC pin. The error signal disappears as well when the current commutates from the low side MOSFET to the associated high side MOSFET (no current through the shunt resistor).

It is the decision of the user to react on the over current signal by modifying the Ixx patterns to lower the current. The overcurrent warning can be disabled by connecting the overcurrent threshold pin to GND ( $V_{THOC} = 0 \text{ V}$ ).

## 5.2.3 Dead Time and Shoot Through Protection

In bridge applications it has to be assured that the external high side and low side MOSFETs are not "on" at the same time, connecting directly the battery voltage to GND. The dead time generated in the TLE7188F is fixed to a minimum value. This function assures a minimum dead time if the input signals coming from the  $\mu$ C are faulty.

The exact dead time of the bridge is usually controlled by the PWM generation unit of the  $\mu C.$ 

In addition to this dead time, the TLE7188F provides a locking mechanism, avoiding that both external MOSFETs of one half bridge can be switched on at the same time. This functionality is called shoot through protection.

If the command to switch on both high and low side switches in the same half bridge is given at the input pins, the command will be ignored.

## 5.2.4 Under voltage Shut Down

The TLE7188F has an integrated under voltage shut down, to assure that the behavior of the device is predictable in all voltage ranges.



If the voltage of a charge pump buffer capacitors CBx reaches the under voltage shut down level for a minimum specified filter time, the gate-source voltage of all external MOSFETs will be actively pulled to low. In this situation the short circuit detection of this output stage is deactivated to avoid a latching shut down of the driver.

As soon as the charge pump buffer voltage recovers, the output stage condition will be aligned to the input patterns automatically. This allows to continue operation of the motor in case of under voltage shut down without a reset by the  $\mu$ C.

Under voltage shut down will not occur when V<sub>S</sub> > 6 V,  $Q_G$  < 250 nC,  $f_{PWM}$  < 25 kHz, and the charge pump capacitors Cxx = 4.7  $\mu$ F.

## 5.2.5 Over voltage Shut Down

The TLE7188F has an integrated over voltage shut down to avoid destruction of the IC at high supply voltages. The voltage is measured at the Vs and the VDH pin. When one of them or all of them exceed the over voltage shut down level for more than the specified filter time then the external MOSFETs are switched off. In addition, over voltage will shut down the charge pumps and will discharge the charge pump capacitors. This results in an under voltage condition which will be indicated on the ERRx pins. During over voltage shut down the external MOSFETs and the charge pumps remain off until a reset is performed.

## 5.2.6 Over temperature Warning

If the junction temperature is exceeding typ. 170°C an error signal is given as warning. The driver IC will continue to operate in order not to disturb the application.

The warning is removed automatically when the junction temperature is cooling down.

It is in the responsibility of the user to protect the device against over temperature destruction.

## 5.2.7 VCC1 Check

To assure a high level of system safety, the TLE7188F provides an VCC1 check.

The 5.0V supply for the I/O of the  $\mu$ C is checked by internally monitoring the voltage applied to the ENA pin.

The VCC1 check is active when the signal on the ENA pin is high and is triggered by the ENA signal going high. The VCC1 check is inactive when no ENA signal is applied or the ENA signal is low (= driver IC disabled). As the ENA pin is a digital input, a low pass filter (< 1 MHz) is integrated to avoid faulty triggering. The filtered ENA signal is then supervised in terms of under voltage and over voltage as a measure of the VCC1 voltage.

In case of under- or over voltage at VCC1, the driver IC is disabled and latched. To restart the output stages, a reset has to be performed with the ENA pin.

## 5.2.8 ERR Pins

The TLE7188F has two status pins to provide diagnostic feedback to the  $\mu$ C. The outputs of these pins are 5V push pull stages, they are either High or Low.

ERR1	ERR2	Driver conditions
Low	Low	Under voltage or VCC1 check error
Low	High	Over temperature or over voltage
High	Low	Short circuit detection or over current
High	High	No errors

## Table 2Overview of error conditions



Error condition restart behavior		Shuts down
Short circuit detection	Latch, reset must be performed at ENA pin	All external Power -MOSFETs
Over current warning	Self clearing	Nothing
Under voltage	Auto restart	All external Power -MOSFETs
Over voltage	Latch, reset must be performed at ENA pin	All external Power -MOSFETs
Over temperature warning	Self clearing	Nothing
VCC1 check	Latch, reset must be performed at ENA pin	All external Power -MOSFETs

#### Table 3 Behaviour at different error conditions

Note: All errors do NOT lead to sleep mode. Sleep mode is only initiated with the INH pin. The latch and restart behaviour allows to distinguish between the different error types combined at the ERR signals.

Priority	Error
1	VCC1 check
2	Short circuit detection
3	Under voltage detection
4	Over voltage detection
5	Over temperature Over current

## Reset of ERROR registers and Disable

The TLE7188F can be reset with the help of the enable pin ENA. If the ENA pin is pulled to low for a specified minimum time, the error registers are cleared and the external MOSFETs are switched off actively.

During disable only the errors under voltage shut down and over temperature warning are shown. Other errors are not displayed.

## 5.2.9 Electrical Characteristics

#### **Electrical Characteristics - Protection and diagnostic functions**

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
Over te	emperature		-				
5.2.1	Over temperature warning <sup>1)</sup>	$T_{j(OW)}$	150	170	190	°C	
5.2.2	Hysteresis for over temperature warning <sup>1)</sup>	d <sub>Tj(OW)</sub>	-	20	-	°C	
Over c	urrent warning					1	
5.2.3	Over current threshold	V <sub>THOC</sub>	2	-	4.5	V	Vs=5.58V
5.2.4	Over current threshold	V <sub>THOC</sub>	2	_	4.8	V	<i>V</i> s=820V
5.2.5	Over current disabled	V <sub>THOC</sub>	-	_	1	V	-

#### Electrical Characteristics - Protection and diagnostic functions (cont'd)

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
5.2.6	Input offset voltage of OC Comp	V <sub>IO</sub>	-50	-	50	mV	-	
5.2.7	Input offset voltage temperature drift of OC Comp <sup>1)</sup>	V <sub>IO</sub>	-50	-	5	mV	-	
5.2.8	Over current threshold hysteresis	d <sub>VTHOC</sub>	25	-	-	mV	<i>V</i> s=5.58V	
5.2.9	Over current threshold hysteresis	d <sub>VTHOC</sub>	50	80	-	mV	<i>V</i> s=820V	
5.2.10	Blanking time of overcurrent	t <sub>btOC</sub>	1.0	1.5	3.0	μs		
Short c	ircuit detection							
5.2.11	Filter time of short circuit protection	t <sub>SCP(off)</sub>	-	6.8	-	μs	On request	
5.2.12	Filter time of short circuit protection	t <sub>SCP(off)</sub>	8	12	16	μs	Default	
5.2.13	Maximum duty cycle for no SCD <sup>2)</sup>	D <sub>ySCDmax</sub>	-	-	6	%	f <sub>PWM</sub> =20kHz at IHx or ILx and at static applied SC	
5.2.14	Minimum duty cycle for periodic SCD <sup>2)</sup>	$D_{ySCDmin}$	13	-	-	%	<i>f</i> <sub>PWM</sub> =20kHz at IHy or ILx and at static applied SC	
5.2.15	Voltage range on VSCD pin to adjust the Vds limit	$V_{\rm SCDL(off)}$	0.5	-	2.5	V	Short circuit detection is active	
5.2.16	Short circuit disable voltage at VSCD pin	$V_{\rm SCDL(dis)}$	4.5	-	5.5	V	Short circuit detection is disabled	
5.2.17	Accuracy of SCD (V <sub>SCDL</sub> /V <sub>DS(off)</sub> )	$A_{\rm SC(off)}$	0.85	-	1.15	-	$V_{\rm SCDL(off)}$ set to 1 2.5V	
5.2.18	Accuracy of SCD	$A_{\rm SC(off)}$	0.7	-	1.3	-	$V_{\rm SCDL(off)}$ set to 0.5	
	(V <sub>SCDL</sub> /V <sub>DS(off)</sub> )						1V	
ERR piı		1	1				I	
	High level output voltage of ERRx	V <sub>OHERR</sub>	4.0	_	5.2	V	<i>I</i> = -0.2mA	
5.2.20	Low level output voltage of ERRx	$V_{OLERR}$	-0.1	-	0.4	V	<i>I</i> = 0.2mA	
	nd under voltage		1				1	
5.2.21	Over voltage shut down	$V_{\rm OV(off)}$	28	_	33	V	-	
5.2.22	Over voltage filter time	t <sub>OV</sub>	30	_	65	μs	-	
5.2.23	Under voltage shut down CB1	$V_{\rm UV1}$	7.4	8.2	9.0	V	CB1 to GND	
5.2.24	Under voltage shut down CB2	$V_{\rm UV2}$	4.2	_	6.2	V	CB2 to VDH	
5.2.25	Hysteresis of under voltage shut down on CB1 and CB2	V <sub>HUV1,2</sub>	-	1.0	-	V	-	
Enable	and reset							
5.2.26	Reset time to clear ERR registers	t <sub>Res1</sub>	2.0	-	-	μs	-	



#### Electrical Characteristics - Protection and diagnostic functions (cont'd)

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
5.2.27	Low time of ENA signal without reset	t <sub>Res0</sub>	-	-	0.5	μs	-	
5.2.28	ENA propagation time (for enable / disable)	t <sub>PENA</sub>	-	-	1.0	μs	-	
5.2.29	Return time to normal operation at auto-restart	t <sub>AR</sub>	-	-	1.0	μs	-	
VCC1 C	Check	1	_1					
5.2.30	Under voltage detection level	V <sub>VCU</sub>	4.0	_	4.5	V	-	
5.2.31	Over voltage detection level	V <sub>VCO</sub>	5.5	_	6.0	V	-	
5.2.32	Under voltage filter time	t <sub>VC</sub>	-	-	0.1	μs	Voltage drop at ENA to 3.5V	
5.2.33	Over voltage filter time	t <sub>VC</sub>	-	-	0.15	μs	Voltage overshoot at ENA to 6V	
5.2.34	Rise time on ENA (to avoid Vcc1 check error)	t <sub>ENA_r</sub>	-	-	2	μs	V <sub>ENA</sub> =14.5V	

1) Not subject to production test; specified by design

 Parameters describe the behaviour of the internal SCD circuit. Therefore only internal delay times are considered. In application dead-/ delay times determined by application circuit (switching times of MOSFETs, adjusted dead time) have to be considered as well.



### **Shunt Signal Conditioning**

## 5.3 Shunt Signal Conditioning

The TLE7188F incorporates three fast and precise operational amplifiers for conditioning and amplification of the shunt signals sensed in the three phases. Additionally, one reference bias buffer is integrated to provide an adjustable bias reference for the three OpAmps. The voltage divider on the VRI pin should be less than 50 kOhm, the filtering capacitor less than 1.2  $\mu$ F - if needed at all. The gain of the OpAmps is adjustable by external resistors within a range of 5 to 15.

When V(ISP) = V(ISN), VO provides the reference voltage VRO. VRO is normally half of the regulated voltage provided from an external voltage regulator for the ADC used to read the current sense signal. The additional buffer allows bi-directional current sensing and permits the adaptation of the reference bias to different  $\mu$ C I/O voltages. The reference buffer assures a stable reference voltage even in the high frequency range.

The reference bias buffer is used for all of the OpAmps. The OpAmps of the TLE7188F demonstrate low offset voltages and very little drift over temperature, thus allowing accurate phase current measurements.

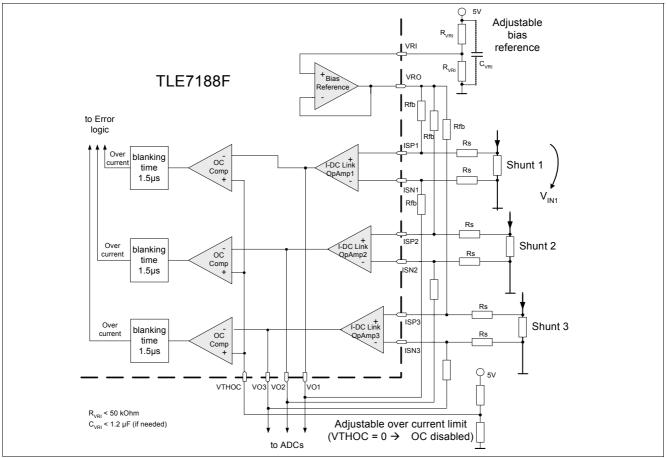


Figure 4 Shunt Signal Conditioning Block Diagram and Over Current Limitation

Over current warning see Chapter 5.2.2.



#### **Shunt Signal Conditioning**

## 5.3.1 Electrical Characteristics

## Electrical Characteristics - Current sense signal conditioning

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C,  $F_{\rm PWM}$  < 25kHz, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.			
5.3.1	Series resistors	R <sub>S</sub>	100	500	1000	Ω	-	
5.3.2	Feedback resistor Limited by the output voltage dynamic range	R <sub>fb</sub>	2000	7500	-	Ω	_	
5.3.3	Resistor ratio (gain ratio)	$R_{\rm fb/RS}$	5	-	15	-	-	
5.3.4	Steady state differential input voltage range across VIN <sup>1)</sup>	$V_{\rm IN(ss)}$	-400	-	400	mV	-	
5.3.5	Input differential voltage (ISPx - ISNx)	$V_{IDR}$	-800	-	800	mV	-	
5.3.6	Input voltage (Both Inputs - GND) (ISP - GND) or (ISN -GND)	V <sub>LL</sub>	-800	-	2000	mV	-	
5.3.7	Input voltage (Both Inputs - GND) (ISP - GND) or (ISN -GND)	V <sub>LL</sub>	-800	-	1500	mV	Vs=5.5V	
5.3.8	Absolute input offset voltage of the I-DC link OpAmp, including drift over temperature range	V <sub>IO</sub>	-	-	2	mV	R <sub>S</sub> =500Ω; V <sub>CM</sub> =0V; V <sub>O</sub> =1.65V; V <sub>RI</sub> =1.65V	
5.3.9	Input offset voltage difference of the I-DC link OpAmps, including drift over temperature range	V <sub>IO</sub>	-	-	+/-1	mV	R <sub>S</sub> =500Ω; V <sub>CM</sub> =0V; V <sub>O</sub> =1.65V; V <sub>RI</sub> =1.65V	
5.3.10	Absolute input offset voltage of reference buffer	V <sub>IO</sub>	-	-	3	mV	-	
5.3.11	VRI input range	V <sub>RI</sub>	1.2	_	2.8	V	-	
5.3.12	Input bias current	$I_{IB}$	-300	_	-	μA	V <sub>CM</sub> =0V; V <sub>O</sub> =open	
5.3.13	High level output voltage of VOx	V <sub>OH</sub>	4.8	-	5.2	V	I <sub>OH</sub> =-2mA; Vs=6V	
5.3.14	Low level output voltage of VOx	V <sub>OL</sub>	-0.1	-	0.2	V	I <sub>OH</sub> =3mA	
5.3.15	Output voltage of VOx $V_{RI}$ = 2.5V, $V_{RI}$ =1.65V,	V <sub>OR</sub>	2.467 1.617	2.50 1.65	2.533 1.683	V	V <sub>IN(SS)</sub> =0V; Gain=15; <i>T</i> j=25°C	
5.3.16	Output short circuit current	I <sub>SC</sub>	5	-	-	mA	-	
5.3.17	Differential input resistance <sup>2)</sup>	R <sub>I</sub>	100	_	-	kΩ	_	
5.3.18	Common mode input capacitance <sup>2)</sup>	I <sub>SC</sub>	-	_	10	pF	10kHz	
5.3.19	Common mode rejection ratio at DC CMRR = 20*Log((Vout_diff/Vin_diff) * (Vin_CM/Vout_CM))	C <sub>MRR</sub>	80	-	-	db	_	



#### **Shunt Signal Conditioning**

#### Electrical Characteristics - Current sense signal conditioning (cont'd)

 $V_{\rm S}$  = 5.5 to 20V,  $T_{\rm j}$  = -40 to +150°C,  $F_{\rm PWM}$  < 25kHz, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions	
			Min.	Тур.	Max.	_		
5.3.20	Common mode suppression <sup>3)</sup> with CMS = 20*Log(Vout_CM/Vin_CM) Freq =100kHz Freq = 1MHz Freq = 10MHz	C <sub>MS</sub>		62 43 33		db	V <sub>IN</sub> =360mV* sin(2*π*freq*t); Rs=500Ω; Rfb=7500Ω; VRI=1.65, 2.5V	
5.3.21	Slew rate	I <sub>SC</sub>	-	10	-	V/µs	Gain>= 5; $R_L$ =1.0kΩ; $C_L$ =500pF	
5.3.22	Large signal open loop voltage gain (DC)	A <sub>OL</sub>	80	100	-	dB	-	
5.3.23	Unity gain bandwidth	GBW	10	20	_	MHz	R <sub>L</sub> =1kΩ; C <sub>L</sub> =100p	
5.3.24	Phase margin <sup>2)</sup>	F <sub>M</sub>	-	50	-	0	Gain>= 5; <i>R</i> <sub>L</sub> =1kΩ; <i>C</i> <sub>L</sub> =100p	
5.3.25	Gain margin <sup>2)</sup>	$A_{M}$	_	12	_	db	R <sub>L</sub> =1kΩ; C <sub>L</sub> =100p	
5.3.26	Bandwidth	B <sub>WG</sub>	1.6	-	-	MHz	Gain=15; $R_{L}$ =1kΩ; $C_{L}$ =500pF; $R_{s}$ =500Ω	
5.3.27	Output settle time to 98% <sup>1)</sup>	t <sub>set</sub>	-	1	1.8	ha	Gain=15; $R_{L}$ =1k $\Omega$ ; $C_{L}$ =500pF; 0.3< $V_{O}$ < 4.8V; Vs>6V, $R_{s}$ =500 $\Omega$	
5.3.28	Output rise time 10% to 90% <sup>1)</sup>	t <sub>lrise</sub>	-	_	1	μs	Gain=15; $R_{L}=1k\Omega;C_{L}=500pH$ 0.3 <vo< 4.8v,<br="">Vs&gt;6V <math>R_{s}=500\Omega</math></vo<>	
5.3.29	Output fall time 90% to 10% <sup>1)</sup>	t <sub>lfall</sub>	-	_	1	μs	Gain=15; $R_{L}$ =1k $\Omega$ ; $C_{L}$ =500pl 0.3< $V_{O}$ < 4.8V; $V_{S}$ >6V; $R_{s}$ =500 $\Omega$ ;	

1) Input current and output amplifier characteristics:

"Output signal must be amplified and available at 2µs after input signal change (Gain 5...15)

2) Not subject to production test; specified by design

3) Without considering any offsets such as input offset voltage, internal miss match and assuming no tolerance error in external resistors.



#### **Application Description**

# 6 Application Description

In the automotive sector there are more and more applications requiring high performance motor drives, such as electro-hydraulic or electric power steering. In these applications 3 phase motors, synchronous and asynchronous, are used, combining high output performance, low space requirements and high reliability.

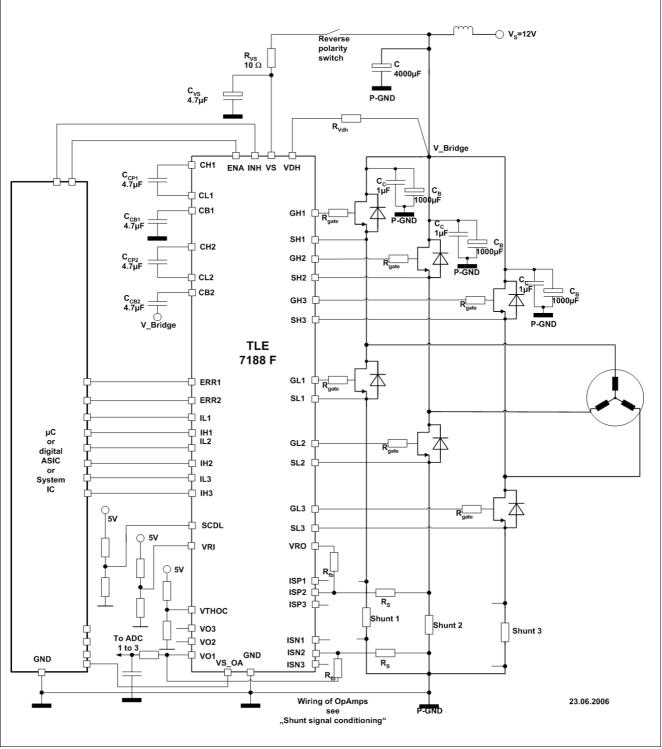


Figure 5 Application Circuit - TLE7188F

Note: This is a very simplified example of an application circuit. The function must be verified in the real application.



## **Application Description**

## 6.1 Layout Guide Lines

Please refer also to the simplified application example.

- Three separated bulk capacitors C<sub>B</sub> should be used one per half bridge
- Three separated ceramic capacitors C<sub>c</sub> should be used one per half bridge
- Each of the 3 bulk capacitors C<sub>B</sub> and each of the 3 ceramic capacitors C<sub>C</sub> should be assigned to one of the half bridges and should be placed very close to it
- The components within one half bridge should be placed close to each other: high side MOSFET, low side MOSFET, bulk capacitor C<sub>B</sub> and ceramic capacitor C<sub>C</sub> (C<sub>B</sub> and C<sub>C</sub> are in parallel) and the shunt resistor form a loop that should be as small and tight as possible. The traces should be short and wide
- The three half bridges can be separated; yet, when there is one common GND referenced shunt resistor for the three half bridges the sources of the three low side MOSFETs should be close to each other and close to the common shunt resistor
- VDH is the sense pin used for short circuit detection; VDH should be routed (via Rvdh) to the common point of the drains of the high side MOSFETs to sense the voltage present on drain high side
- CB2 is the buffer capacitor of charge pump 2; its negative terminal should be routed to the common point of the drains of the high side MOSFETs as well this connection should be low inductive / resistive
- Additional R-C snubber circuits (R and C in series) can be placed to attenuate/suppress oscillations during switching of the MOSFETs, there may be one or two snubber circuits per half bridge, R (several Ohm) and C (several nF) must be low inductive in terms of routing and packaging (ceramic capacitors)
- the exposed pad on the backside of the VQFN is recommended to connect to GND

## 6.2 Further Application Information

• For further information you may contact http://www.infineon.com/



#### **Package Outlines**

# 7 Package Outlines

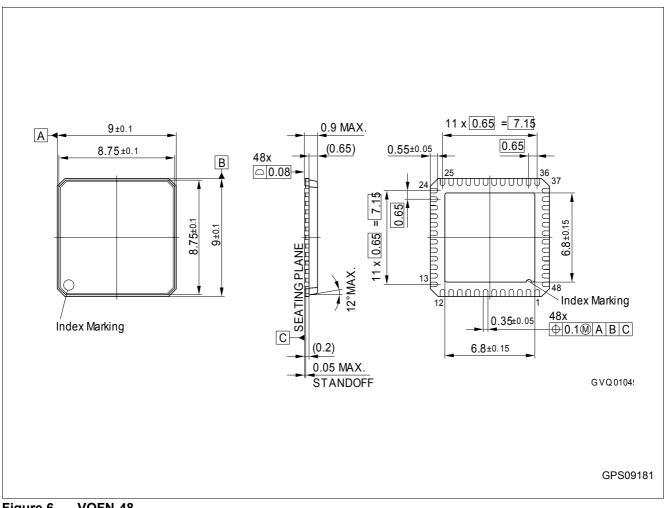


Figure 6 VQFN-48

## **Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).



**Revision History** 

# 8 Revision History

Version	Date	Changes
V2.1 2007-06-2	2007-06-20	Description and Electrical Characteristics - MOSFET driver, Output Stages: Start up described in more detail
		Electrical characteristics - MOSFET drivers: Turn on current, peak, specified as negative current (going out of the pin GHx and GLx)
		Electrical characteristics - Current sense signal conditioning: Input bias current specified as negative current (going out of the pin ISNx and ISPx)

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